



REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
C		INITIAL RELEASE	APR 18/06	ML
D		PCB SOLDER PAD WIDTH REVISED FROM .010" TO .014"	FEB 19/07	ZU
E		TOLERANCE ADDED TO PCB HOLE & LOCATING PIN	FEB 27/07	ZU
F		FS1-R26-3000 ADDED	APR 05/07	JL
G		DIAM. PEG DRMS ADDED, TOLERANCE ADDED TO .472	AUG 06/07	ZU
H		HOUSING MODIFIED	AUG 23/07	ZU
J		IMPERIAL UNITS REMOVED	OCT 4/07	ZU

PART NUMBER	PACKAGING	CONTACT PLATING
FS1-R26-2000	TAPE AND REEL	30 μ " GOLD OVER 50 μ " NICKEL IN CONTACT AREAS 100 μ " MATTE TIN OVER 50 μ " NICKEL IN SOLDER AREAS
FS1-R26-3000		15 μ " GOLD OVER 50 μ " NICKEL IN CONTACT AREAS 100 μ " MATTE TIN OVER 50 μ " NICKEL IN SOLDER AREAS

- NOTES:
- MATERIAL:
HOUSING: SOLDER REFLOW PROCESS COMPATIBLE LCP, UL94V-0
CONTACTS: PHOSPHOR BRONZE
 - ROHS COMPLIANT
 - PERFORMANCE:
ELECTRICAL: 0.5 AMPS MAX. PER CONTACT
MECHANICAL: 250 MATING CYCLES MINIMUM
 - COMPLIES WITH SFF-8086



UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ARE:		APPROVALS		DATE	Amphenol Canada Corp.	
DIMENALS	ANGLES	DRAWN	YK	15/FEB/06	TITLE	
X ± 0.25	± 2°	CHECKED	YK	15/FEB/06	SFF, 26 POSITION CONNECTOR	
XX ± 0.13		DATE				
MATERIAL AND FINISH		DATE				
ENG. REV. EAR		DATE			REV. J	P-FS1-R26-X000
CODE IDENT. NO. 03554		DATE			REV. C	
		DATE			REV. NTS	
		DATE			REV. SFF	
		DATE			REV. 1 OF 1	

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DO NOT SCALE DRAWING

RECOMMENDED PCB LAYOUT

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